FEATURES
- Lead-Free RoHS/WEEE-compliant
- Convert surface mount PLCC packages to a PGA footprint
- Pin polarization option also available
- Consult factory for Panelized Form or for mounting of consigned chips

GENERAL SPECIFICATIONS
- ADAPTER BODY: FR-4, 0.062 [1.58] thick, with 1-oz. min. Cu traces
- PADS: hot-air solder leveled
- PINS: Brass 360 1/2-hard per UNS C36000 ASTM-B16-00
- PIN PLATING: 200µ [5.08µ] Sn/Pb 93/7 ASTM B579-73 over 100µ [2.54µ] Ni per ASE AMS-QQ-N-290 or 10µ [0.25µ] Au
- OPERATING TEMPERATURE: 221°F [105°C]

MOUNTING CONSIDERATIONS
- SUGGESTED PCB HOLE SIZE: 0.028 ±0.003 [0.71 ±0.08] dia
- STANDARD: will plug into PGA socket

ALL DIMENSIONS: INCHES [MILLIMETERS]
ALL TOLERANCES: ±0.005 [0.13] UNLESS OTHERWISE SPECIFIED
CONSULT FACTORY FOR OTHER SIZES AND CONFIGURATIONS

CUSTOMIZATION: In addition to the standard products shown on this page, Aries specializes in custom design and production. Special materials, platings, sizes, and configurations can be furnished, depending on the quantity. NOTE: Aries reserves the right to change product general specifications without notice.

ORDERING INFORMATION
XX-505-11 X-P
No. of Pins
28, 44, 68, 84
or 29, 45, 69, 85
with Polarization Pin
Series
Stand-offs w/Solder Pin Tail
Optional Panelized Version
Pin Plating
0 = Sn (standard)
1 = Au

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28 or 29 | 0.600 [15.24] | 0.500 [12.70] | 0.448 [11.38] | 0.324 [8.23] | 29-PGM06002-10
44 or 45 | 0.800 [20.32] | 0.700 [17.78] | 0.648 [16.46] | 0.524 [13.31] | 44-PGM08002-10
68 or 69 | 1.100 [27.94] | 1.000 [25.40] | 0.948 [24.08] | 0.824 [20.93] | 68-PGM11032-10